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U.S.S.N. 10/600,799

AUG 2 5 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

In re: Application of: Kuo-Lung Lei

Group Art Unit: 2814

Serial No.:

10/600,799

Examiner: Weiss, Howard

Filed:

June 18, 2003

In Response to Office Action

Dated: May 25, 2005

For:

MEM Micro-Cap Wafer Level Chip Scale Package

Attorney Docket No.: 68,700-015

CERTIFICATE OF MAILING OR FACSIMILE TRANSMISSION

I hereby certified that this correspondence is (1) \square being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P O Box 1450, Alexandria, VA 22313-1450 on August 25, 2005; or (2) Deing facsimile transmitted to the United States Patent and Trademark Office at facsimile number (571)-273-8300 on August 25, 2005.

Randy W. Tung

Printed Name

Signature

8/25/05

Please forward all correspondence to **TUNG & ASSOCIATES** 838 W. Long Lake Road, Suite 120 Bloomfield Hills, MI 48302

Commissioner for Patents Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action dated May 25, 2005, please enter the following amendments and consider the following remarks.